

August 2010

NC7SP04 — TinyLogic® ULP Inverter

Features

- 0.9V to 3.6V V_{CC} Supply Operation
- 3.6V Over-Voltage Tolerant I/Os at V_{CC} from 0.9V to 3.6V
- Propagation Delay (t_{PD}):
 - 4.0ns Typical for 3.0V to 3.6V V_{CC}
 - 5.0ns Typical for 2.3V to 2.7V V_{CC}
 - 6.0ns Typical for 1.65V to 1.95V V_{CC}
 - 7.0ns Typical for 1.40V to 1.60V V_{CC}
 - 11.0ns Typical for 1.10V to 1.30V V_{CC}
 - 27.0ns Typical for 0.90V V_{CC}
- Power-Off High-Impedance Inputs and Outputs
- Static Drive (I_{OH}/I_{OL}):
 - ± 2.6mA at 3.00V V_{CC}
 - ± 2.1mA at 2.30V V_{CC}
 - ± 1.5mA at 1.65V V_{CC}
 - ± 1.0mA at 1.40V V_{CC}
 - ± 0.5mA at 1.10V V_{CC}
 - ± 20µA at 0.9V V_{CC}
- Quiet Series™ Noise / EMI Reduction Circuitry
- Ultra Small MicroPak™ Packages
- Ultra Low Dynamic Power

Description

The NC7SP04 is a single inverter from Fairchild's Ultra Low Power (ULP) series of TinyLogic®. Ideal for applications where battery life is critical, this product is designed for ultra low power consumption within the $V_{\rm CC}$ operating range of 0.9V to 3.6V.

The internal circuit is composed of a minimum of inverter stages, including the output buffer, to enable ultra low static and dynamic power.

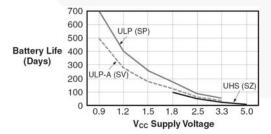
The NC7SP04, for lower drive requirements, is uniquely designed for optimized power and speed and is fabricated with an advanced CMOS technology to achieve best-in-class speed of operation, while maintaining extremely low CMOS power dissipation.

Related Resources

 AN-5055 — Portability and Ultra Low Power <u>TinyLogic®</u>

Ordering Information

Part Number Top Mark		Package	Packing Method
NC7SP04P5X	P04	5-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3000 Units on Tape & Reel
NC7SP04L6X	J6	6-Lead MicroPak™, 1.00mm Wide	5000 Units on Tape & Reel
NC7SP04FHX	J6	6-Lead, MicroPak2, 1x1mm Body, .35mm Pitch	5000 Units on Tape & Reel



Notes:

- TinyLogic ULP and ULP-A with up to 50% less power consumption can extend battery life significantly.
- Battery Life=(V_{battery} x I_{battery} x 0.9) / (P_{device}) / 24hrs/day; where, P_{device}=(I_{CC} x V_{CC}) + (C_{PD} + C_L) x V_{CC}² x f.
- Assumes ideal 3.6V Lithium Ion battery with current rating of 900mAH and derated 90% and device frequency at 10MHz, with C_L=15pF load.

Figure 1. Battery Life vs. V_{CC} Supply Voltage

Connection Diagrams

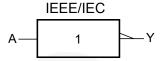


Figure 2. Logic Symbol

Pin Configurations

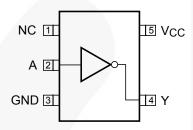


Figure 3. SC70 (Top View)

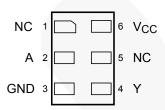


Figure 4. MicroPak (Top Through View)

Function Table

Inputs	Output
A	Y
L	Н
Н	L

L = Low Logic Level H = High Logic Level

Pin Definitions

Pin # SC70	Pin # MicroPak	Name	Description
1	1, 5	NC	No Connect
2	2	Α	Input
3	3	GND	Ground
4	4	Y	Output
5	6	V _{CC}	Supply Voltage

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Para	Min.	Max.	Unit	
V _{CC}	Supply Voltage		-0.5	4.6	V
V _{IN}	DC Input Voltage		-0.5	4.6	V
V	DC Output Voltage	HIGH or LOW State ⁽⁴⁾	-0.5	V _{CC} to +0.5	V
V_{OUT}	DC Output Voltage	V _{CC} =0V	-0.5	4.6	V
I _{IK}	DC Input Diode Current at V _{IN} <	: 0V		-50	mA
	DC Output Diada Current	V _{OUT} < 0V		-50	m Λ
I _{OK}	DC Output Diode Current	V _{OUT} > V _{CC}		+50	mA
I _{OH} / I _{OL}	DC Output Source/Sink Current			±50	mA
I _{CC} or Ground	DC V _{CC} or Ground Current per	Supply Pin		±50	mA
T _{STG}	Storage Temperature Range		-65	+150	°C
TJ	Junction Temperature Under Bi	as		+150	°C
TL	Junction Lead Temperature (Sc	oldering, 10 Seconds)		+260	°C
A		SC70-5		150	
P_{D}	Power Dissipation at +85°C	MicroPak-6		130	mW
		MicroPak2-6		120	
ESD	Human Body Model	JEDEC: JESD22-A114		4000	V
ESD	Charged Device Model	JEDEC: JESD22-C101		2000	V

Note:

4. The I_O maximum rating must be observed.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Conditions	Min.	Max.	Unit	
Vcc	Supply Voltage		0.9	3.6	V	
V _{IN}	Input Voltage ⁽⁵⁾		0	3.6	V	
\/	Cutaut Valtage	HIGH or LOW State	0	V _{CC}	V	
V _{OUT}	Output Voltage	V _{CC} =0V	0	3.6]	
		V _{CC} =3.0V to 3.6V		±2.6		
		V _{CC} =2.3V to 2.7V		±2.1	mA	
1 /1	Output Compatin I / I	V _{CC} =1.65V to 1.95V		±1.5		
I _{OH} / I _{OL}	Output Current in I _{OH} / I _{OL}	V _{CC} =1.40V to 1.60V		±1.0		
		V _{CC} =1.10V to 1.30V		±0.5		
		V _{CC} =0.9V		20.0	μΑ	
T _A	Free Air Operating Temperature		-40	+85	°C	
Δt / ΔV	Minimum Input Edge Rate	V _{IN} =0.8V to 2.0V, V _{CC} =3.0V		10	ns/V	
		SC70-5		425		
θ_{JA}	Thermal Resistance	MicroPak-6		500	°C/W	
		MicroPak2-6		560		

Note:

5. Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Cumbal	Doromotor	V Condi	Canditions	T _A =25°C		5°C T _A =-40 to 85°C		
Symbol	Parameter	V _{CC}	Conditions	Min.	Max.	Min.	Max.	Unit
		0.90		0.65 x V _{CC}		0.65 x V _{CC}		
		1.10 ≤ V _{CC} ≤ 1.30		0.65 x V _{CC}		0.65 x V _{CC}		
	HIGH Level Input	1.40 ≤ V _{CC} ≤ 1.60		0.65 x V _{CC}		0.65 x V _{CC}		١/
V_{IH}	Voltage	1.65 ≤ V _{CC} ≤ 1.95		0.65 x V _{CC}		0.65 x V _{CC}		V
		2.30 ≤ V _{CC} ≤ 2.70		1.6		1.6		
		3.00 ≤ V _{CC} ≤ 3.60		2.1		2.1		
		0.90			0.35 x V _{CC}		0.35 x V _{CC}	
		1.10 ≤ V _{CC} ≤ 1.30			0.35 x V _{CC}		0.35 x V _{CC}	
.,	LOW Level Input	1.40 ≤ V _{CC} ≤ 1.60			0.35 x V _{CC}		0.35 x V _{CC}	
V_{IL}	Voltage	1.65 ≤ V _{CC} ≤ 1.95			0.35 x V _{CC}		0.35 x V _{CC}	V
		2.30 ≤ V _{CC} ≤ 2.70			0.7		0.7	
		3.00 ≤ V _{CC} ≤ 3.60			0.9		0.9	
7		0.90		V _{CC} - 0.1		V _{CC} - 0.1		
		1.10 ≤ V _{CC} ≤ 1.30		V _{CC} ₋ 0.1		V _{CC} - 0.1		
	/	1.40 ≤ V _{CC} ≤ 1.60		V _{CC} - 0.1		V _{CC} - 0.1		
	7	1.65 ≤ V _{CC} ≤ 1.95	—I _{OH} =-20μA	V _{CC} - 0.1		V _{CC} - 0.1		
		2.30 ≤ V _{CC} ≤ 2.70		V _{CC} - 0.1		V _{CC} - 0.1		١.
V_{OH}	/ _{OH} HIGH Level Output Voltage	3.00 ≤ V _{CC} ≤ 3.60		V _{CC} - 0.1		V _{CC} - 0.1		٧
	Voltage	1.10 ≤ V _{CC} ≤ 1.30	I _{OH} =-0.5mA	0.75 x V _{CC}		0.75 x V _{CC}		
		1.40 ≤ V _{CC} ≤ 1.60	I _{OH} =-1mA	1.07		0.99		
		1.65 ≤ V _{CC} ≤ 1.95	I _{OH} =-1.5mA	1.24		1.22		
		2.30 ≤ V _{CC} ≤ 2.70	I _{OH} =-2.1mA	1.95		1.87		
		3.00 ≤ V _{CC} ≤ 3.60	I _{OH} =-2.6mA	2.61		2.55		
		0.90	V /		0.1		0.1	
		1.10 ≤ V _{CC} ≤ 1.30			0.1		0.1	
		1.40 ≤ V _{CC} ≤ 1.60			0.1		0.1	
		1.65 ≤ V _{CC} ≤ 1.95	—I _{OL} =20μA		0.1		0.1	7
		2.30 ≤ V _{CC} ≤ 2.70			0.1		0.1	
V_{OL}	LOW Level Output Voltage	3.00 ≤ V _{CC} ≤ 3.60			0.1		0.1	٧
	Voltage	1.10 ≤ V _{CC} ≤ 1.30	I _{OL} =0.5mA		0.30 x V _{CC}		0.30 x V _{CC}	
		1.40 ≤ V _{CC} ≤ 1.60	I _{OL} =1mA		0.31		0.37	
		1.65 ≤ V _{CC} ≤ 1.95	I _{OL} =1.5mA	4-1	0.31		0.35	
	2.30 ≤ V _{CC} ≤ 2.70	I _{OL} =2.1mA		0.31		0.33		
		3.00 ≤ V _{CC} ≤ 3.60	I _{OL} =2.6mA		0.31	4.0	0.33	
I _{IN}	Input Leakage Current	0.90 to 3.60	0 ≤ V _I ≤ 3.6V		±0.1		±0.5	μΑ
I _{OFF}	Power Off	0	$0 \le (V_O, V_I) \le 3.6V$		0.5		0.5	μA
I _{CC}	Quiescent Supply Current	0.90 to 3.60	V _{IN} =V _{CC} or GND		0.9		0.9	μA

AC Electrical Characteristics

Comple at	Downwater	.,	Conditions	T _A =25°C			T _A =-40 to 85°C		l Inite	Figure 2	
Symbol	Parameter	V _{CC}	Conditions	Min.	Тур.	Max.	Min.	Max.	Units	Figure	
		0.90			27.0						
		1.10 ≤ V _{CC} ≤ 1.30		3.5	11.0	21.8	3.0	34.3			
		1.40 ≤ V _{CC} ≤ 1.60	C _L =10pF,	2.5	7.0	14.8	2.0	15.0			
		1.65 ≤ V _{CC} ≤ 1.95	R_L =1M Ω	2.0	6.0	12.0	1.5	12.2			
		2.30 ≤ V _{CC} ≤ 2.70		1.5	5.0	9.4	1.0	9.9			
		$3.00 \le V_{CC} \le 3.60$		1.0	4.0	8.3	1.0	9.0			
		0.90			30.0					Figure 1,	
		$1.10 \le V_{CC} \le 1.30$	C_L =15pF, R_L =1M Ω	4.0	11.0	22.8	3.5	37.3	ns		
	Propagation Delay	1.40 ≤ V _{CC} ≤ 1.60		3.0	8.0	15.5	2.5	16.5			
t _{PHL} , t _{PLH}	Propagation Delay	1.65 ≤ V _{CC} ≤ 1.95		R _L =1MΩ	2.5	6.0	12.6	2.0	13.6	115	Figure 2
		$2.30 \le V_{CC} \le 2.70$			2.0	5.0	9.9	1.5	10.8		
		$3.00 \le V_{CC} \le 3.60$		1.5	4.0	8.7	1.0	9.5			
		0.90			32.0						
	3/	1.10 ≤ V _{CC} ≤ 1.30		5.0	13.0	25.9	4.0	46.3			
		1.40 ≤ V _{CC} ≤ 1.60	C _L =30pF,	4.0	9.0	17.8	3.5	18.2			
		$1.65 \le V_{CC} \le 1.95$	R_L =1M Ω	3.0	7.0	14.4	2.0	15.9			
		$2.30 \le V_{CC} \le 2.70$		2.0	6.0	11.3	1.5	12.8		\-	
		$3.00 \le V_{CC} \le 3.60$		1.5	5.0	9.2	1.0	10.7			
C _{IN}	Input Capacitance	0			2					pF	
C _{PD}	Power Dissipation Capacitance	0.90 to 3.60	V _{IN} =0V or V _{CC} , f=10MHz		8					pF	

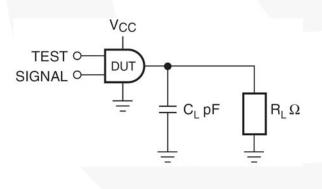


Figure 5. AC Test Circuit

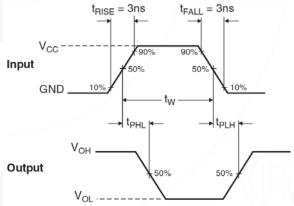


Figure 6. AC Waveforms

Symbol	V _{cc}					
	3.3V ± 0.3V	2.5V ± 0.2V	1.8V ± 0.15V	1.5V ± 0.1V	1.2V ± 0.1V	0.9V
V _{mi}	1.5V	V _{CC} / 2				
V_{mo}	1.5V	V _{CC} / 2				

Physical Dimensions

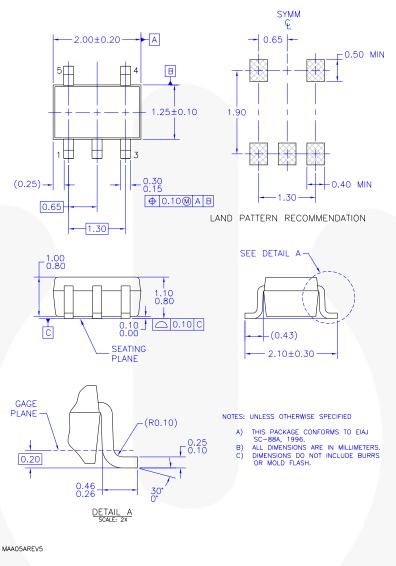


Figure 7. 5-Lead, SC70, EIAJ SC-88a, 1.25mm Wide

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Tape and Reel Specification

Please visit Fairchild Semiconductor's online packaging area for the most recent tape and reel specifications: http://www.fairchildsemi.com/products/analog/pdf/sc70-5 tr.pdf.

Package Designator	Package Designator Tape Section		Cavity Status	Cover Type Status	
	Leader (Start End)	125 (Typical)	Empty	Sealed	
P5X	Carrier	3000	Filled	Sealed	
	Trailer (Hub End)	75 (Typical)	Empty	Sealed	

Physical Dimensions

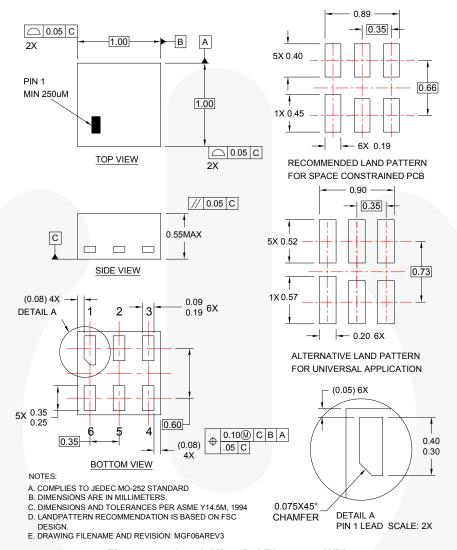


Figure 8. 6-Lead, MicroPak™, 1.0mm Wide

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Tape and Reel Specification

Please visit Fairchild Semiconductor's online packaging area for the most recent tape and reel specifications: http://www.fairchildsemi.com/products/logic/pdf/micropak_tr.pdf.

Package Designator Tape Section		Cavity Number	Cavity Status	Cover Type Status	
	Leader (Start End)	125 (Typical)	Empty	Sealed	
L6X	Carrier	5000	Filled	Sealed	
	Trailer (Hub End)	75 (Typical)	Empty	Sealed	

Physical Dimensions

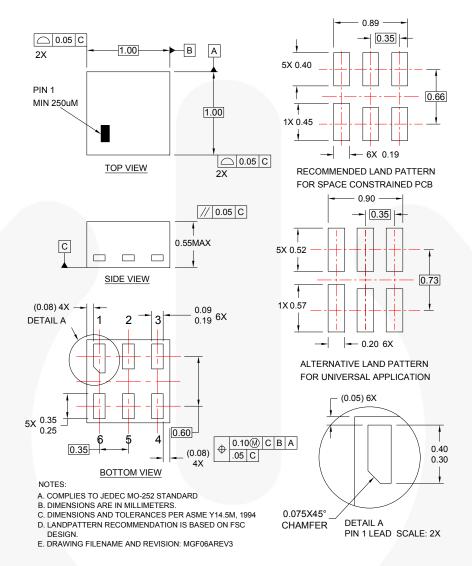


Figure 9. 6-Lead, MicroPak2, 1x1mm Body, .35mm Pitch

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Tape and Reel Specification

Please visit Fairchild Semiconductor's online packaging area for the most recent tape and reel specifications: http://www.fairchildsemi.com/packaging/MicroPAK2_6L_tr.pdf.

Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
FHX	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed





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No Identification Needed	Full Production	Datasheet contains final specifications, Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
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